

Trench™ Power MOSFET

N-Channel Enhancement Mode

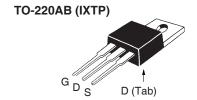
IXTA76N25T IXTP76N25T IXTQ76N25T IXTH76N25T $V_{DSS} = 250V$ $I_{D25} = 76A$

 $R_{DS(on)} \leq 44m\Omega$

Typical Avalanched BV = 300V

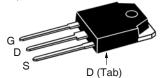




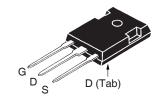




TO-3P (IXTQ)



TO-247(IXTH)



G = Gate	D	=	Drain
S = Source	Tab	=	Drain

Symbol	Test Conditions	Maximum F	Ratings
V _{DSS}	$T_J = 25^{\circ}\text{C to } 150^{\circ}\text{C}$	250	V
V _{DGR}	$T_J = 25^{\circ}\text{C to } 150^{\circ}\text{C}, R_{GS} = 1\text{M}\Omega$	250	
V _{GSS}	Continuous	± 20	V
V _{GSM}	Transient	± 30	
I _{D25}	$T_{\rm C} = 25^{\circ}{\rm C}$	76	A
	$T_{\rm C} = 25^{\circ}{\rm C}$, Pulse Width Limited by $T_{\rm JM}$	170	A
I _A	$T_{c} = 25^{\circ}C$	8	A
E _{AS}	$T_{c} = 25^{\circ}C$	1.5	J
P _D	T _C = 25°C	460	W
T _J		-55 +150	°C
T _{JM}		150	°C
T _{stg}		-55 +150	°C
T _L	Maximum Lead Temperature for Soldering Plastic Body for 10s	300	°C
T _{SOLD}		260	°C
F _c	Mounting Force (TO-263) 10	65 / 2.214.6	N/lb
M _d	Mounting Torque (TO-220, TO-3P & TO-247)	1.13/10	Nm/lb.in
Weight	TO-263 TO-220 TO-3P TO-247	2.5 3.0 5.5 6.0	g g

Features

- Avalanche Rated
- High Current Handling Capability
- Fast Intrinsic Rectifier
- Low R_{DS(on)}

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- DC-DC Converters
- Battery Chargers
- Switch-Mode and Resonant-Mode Power Supplies
- DC Choppers
- AC Motor Drives
- Uninterruptible Power Supplies
- High Speed Power Switching Applications

			cteristic Typ.	Values Max.	
BV _{DSS}	$V_{GS} = 0V, I_D = 1mA$ $V_{GS} = 0V, I_D = 10mA$	250	300		V V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250\mu A$	3.0		5.0	V
I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 100	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 125^{\circ}$	°C		2 200	μ Α μ Α
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 0.5 \bullet I_{D25}, \text{ Note 1}$			44	mΩ



Symbol (T _J = 25°C U	Test Conditions Unless Otherwise Specified)	Chara Min.	cteristic '	Values Max.
g _{fs}	V _{DS} = 10V, I _D = 0.5 • I _{D25} , Note 1	43	72	S
C _{iss}			4920	pF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		470	pF
C _{rss}			70	pF
t _{d(on)}	Parietics Contabine Times		22	ns
t,	Resistive Switching Times		25	ns
t _{d(off)}	$V_{GS} = 15V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		56	ns
t _f	$R_{\rm G} = 3.3\Omega$ (External)		29	ns
Q _{g(on)}			92	nC
Q _{gs}	$V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 25A$		28	nC
Q_{gd}			21	nC
R _{thJC}				0.27 °C /W
\mathbf{R}_{thCH}	TO-220		0.50	°C W
	TO-3P & TO-247		0.25	°C W

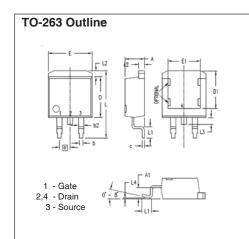
Source-Drain Diode

Symbol (T _J = 25°C l	Test Conditions Unless Otherwise Specified)	Chara Min.	cteristic Typ.	Values Max.	
I _s	$V_{GS} = 0V$			76	Α
I _{SM}	Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$			200	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0V$, Note 1			1.5	V
t _{rr}	$I_{\rm F} = 38A$, -di/dt = 250A/ μ s		148		ns
I _{RM}	$V_{B} = 100V, V_{GS} = 0V$		21		Α
Q_{RM}	$V_{R} = 100V, V_{GS} = 0V$		1.6		μС

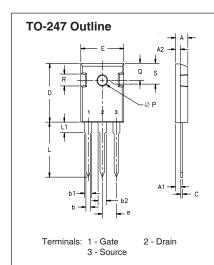
Note 1: Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.



IXTA76N25T IXTH76N25T IXTP76N25T IXTQ76N25T



MY2	INCHES		MILLIMETERS	
2114	MIN	MAX	MIN	MAX
Α	.160	.190	4.06	4.83
A1	.080.	.110	2.03	2.79
Ь	.020	.039	0.51	0.99
b2	.045	.055	1.14	1.40
С	.016	.029	0.40	0.74
c2	.045	.055	1.14	1.40
D	.340	.380	8.64	9.65
D1	.315	.350	8.00	8.89
Ε	.380	.410	9,65	10.41
E1	.245	.320	6.22	8.13
е	.100	BSC	2.54	BSC
L	.575	.625	14.61	15.88
L1	.090	.110	2.29	2.79
L2	.040	.055	1.02	1.40
L3	.050	.070	1.27	1.78
L4	0	.005	0	0.13

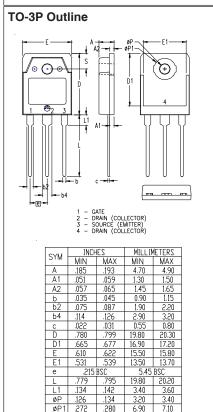


Dim.	Millimeter		Inc	hes
	Min.	Max.	Min.	Max.
Α	4.7	5.3	.185	.209
A,	2.2	2.54	.087	.102
A ₂	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b,	1.65	2.13	.065	.084
b ₂	2.87	3.12	.113	.123
С	.4	.8	.016	.031
D	20.80	21.46	.819	.845
E	15.75	16.26	.610	.640
е	5.20	5.72	0.205	0.225
L	19.81	20.32	.780	.800
L1		4.50		.177
ØP	3.55	3.65	.140	.144
Q	5.89	6.40	0.232	0.252
R	4.32	5.49	.170	.216
S	6.15	BSC	242	BSC

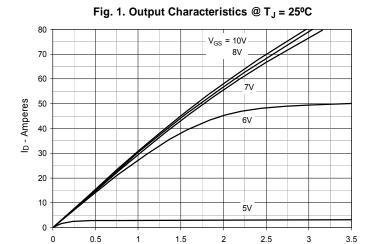
TO-220 Outline

Pins: 1 - Gate 2 - Drain 3 - Source

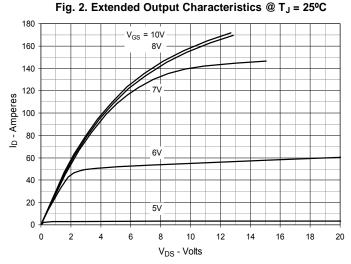
MYZ	INCHES		MILLIMETERS	
2114	MIN	MAX	MIN	MAX
Α	.170	.190	4.32	4.83
b	.025	.040	0.64	1.02
b1	.045	.065	1.15	1.65
С	.014	.022	0.35	0.56
D	.580	.630	14.73	16.00
E	.390	.420	9.91	10.66
е	.100	BSC	2.54 BSC	
F	.045	.055	1.14	1.40
H1	.230	.270	5.85	6.85
J1	.090	.110	2.29	2.79
k	0	.015	0	0.38
L	.500	.550	12.70	13.97
L1	.110	.230	2.79	5.84
ØΡ	.139	.161	3.53	4.08
Q	.100	.125	2.54	3.18

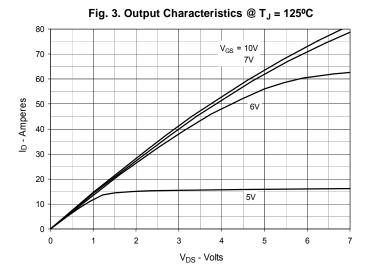


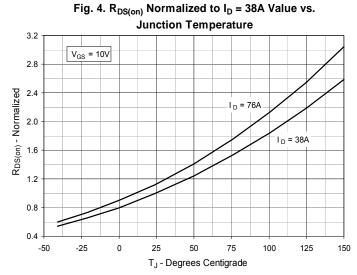


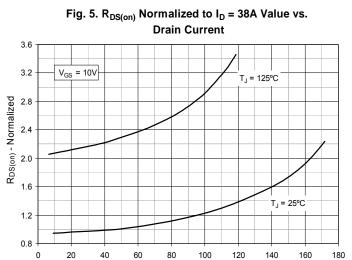


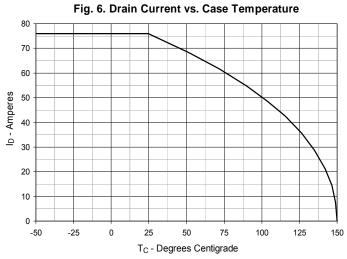
V_{DS} - Volts





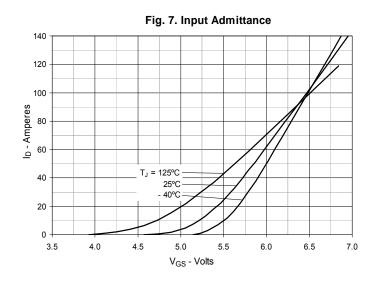


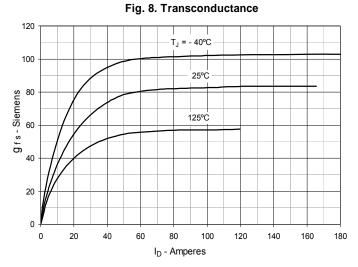


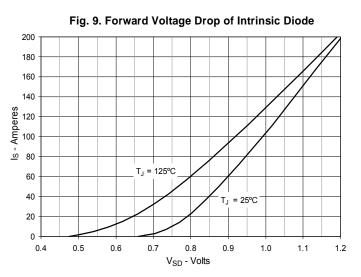


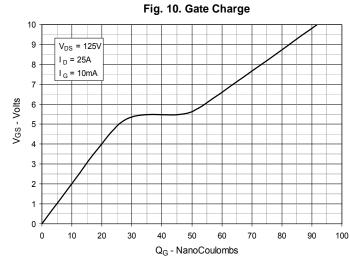
 $$\rm I_D\,\textsc{-}$ Amperes IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

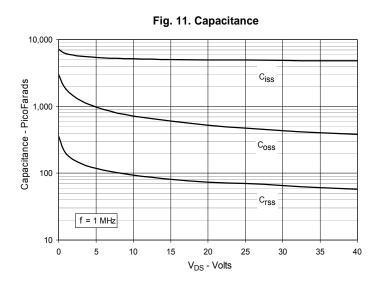












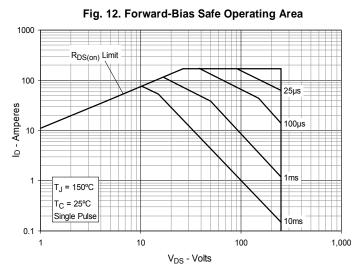
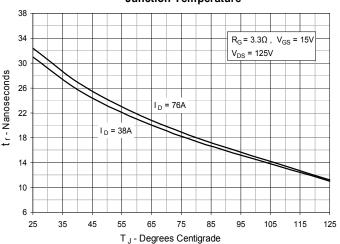


Fig. 13. Resistive Turn-on Rise Time vs. **Junction Temperature**



Drain Current

Fig. 14. Resistive Turn-on Rise Time vs.

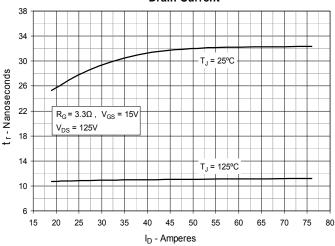


Fig. 15. Resistive Turn-on Switching Times vs. **Gate Resistance**

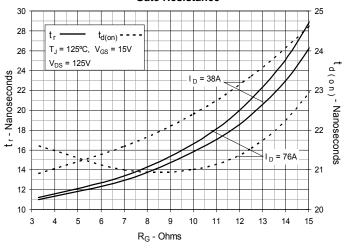


Fig. 16. Resistive Turn-off Switching Times vs.

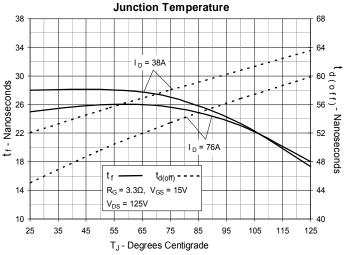


Fig. 17. Resistive Turn-off Switching Times vs. **Drain Current**

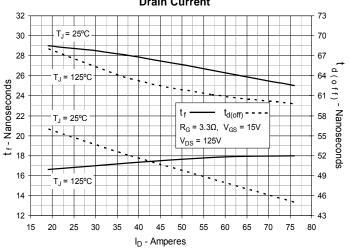
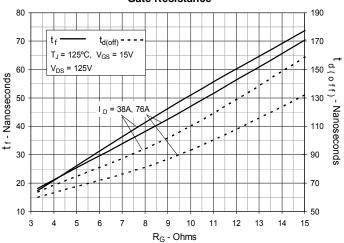


Fig. 18. Resistive Turn-off Switching Times vs. **Gate Resistance**



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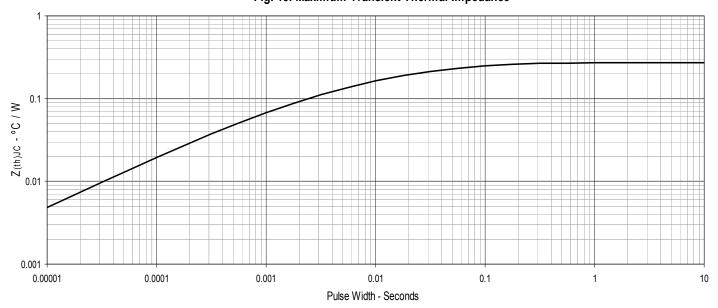


Fig. 19. Maximum Transient Thermal Impedance

